Approved	by:
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SPECIFICATION

PRODUCT: SAW FILTER

MODEL: HDBF31A2M SIP5K



SHOULDER ELECTRONICS LIMITED

1.SCOPE

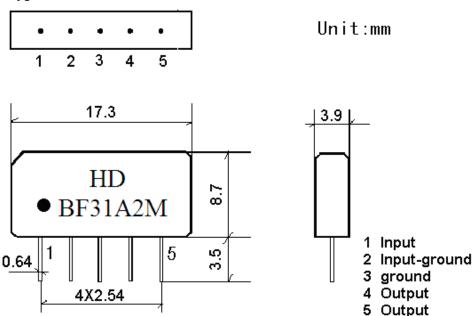
SHOULDER'S SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. they are used in electronic equipments such as TV and so on.

2. Construction

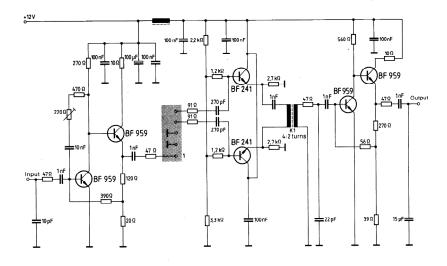
2.1 Dimension and materials

Manufacturer's name: SHOULDER ELECTRONICS Co. LTD(CHINA)

Type: BF31A2M



2.2. Circuit construction, measurement circuit



Test circuit for SIP-5 filter Input impedance of the symmetrical post-amplifier: 2 k Ω in parallel with 3 pF

3. Characteristics

Items	Conditions	Specifications
Standard atmospheric conditions	Unless otherwise specified, the standard rang of atmospheric conditions for making measurements and tests is as follows; Ambient temperature : 15°C to 35°C Relative humidity : 25% to 85% Air pressure : 86kPa to 106kPa	
Operating temperature rang	Operating temperature rang is the rang of ambient temperatures in which the filter can be operated continuously. $-10^{\circ}\text{C} \sim +60^{\circ}\text{C}$	There shall be no damage.
Storage temperature rang	Storage temperature rang is the rang of ambient temperatures at which the filter can be stored without damage. Conditions are as specified elsewhere in these specifications. $-40^{\circ}\text{C} \sim +70^{\circ}\text{C}$	
Reference temperature	+25℃	

3.1 Maximum Rating

DC voltage	VDC	12	\mathbf{V}	Between any terminals
AC voltage	Vpp	10	\mathbf{V}	Between any terminals

3.2 Electrical Characteristics

Source impedance $Zs=50 \Omega$

Load impedance $Z_L=2k\ \Omega\ //3pF$ $T_A=25\ ^{\circ}C$

		1			2.1	
Iten	n	Freq	min	typ	max	
	Center frequency (center between 10dB point)		-	31.00	-	MHz
Insertion attenuation Reference level		31.00MHz	-	16.5	18.5	dB
Dogg be	D 1 1 11		-	0.5	-	MHz
Pass bandwidth		B30dB	-	1.7	2.0	MHz
	22.60~2		35.0	62.0		dB
Sidelobe			32.0	50.0		dB
Sidelobe	32.20~	33.40MHz	32.0	50.0		dB
	33.40~	42.60MHz	35.0	52.0		dB
Temperature coefficient			-18		ppm/k	

3.3Environmental Performance Characteristics

Item		Conditio			Specifications
High	The specimen shall be store at a temperature of			Specifications	
temperature	80±2°C for 96±4h. Then it shall be subjected to				
r		d atmospheric cond	•		
		neasurement shall be			
Low		ecimen shall be store			
temperature	_	for 96±4h. Then i	-		
		d atmospheric cond			
		neasurement shall be			
Humidity	The spe	cimen shall be store	e at a temperat	ure of	
	40±2℃	with relative humi-	dity of 90% to	96%	
	for 96:	±4h. Then it shall be	subjected to sta	andard	
	atmospl	neric conditions fo	or 1h, after	which	
	measure	ement shall be made	within 1h.		
Thermal	The spe	cimen shall be subje	ected to 8 conti	nuous	
shock		each as shown belo			
		ed to standard atmos	•		
	i i	er which measuren	nent shall be	made	
	within 1		D :	1	
	1	Temperature	Duration	-	
	1	+25°C=>-40°C	0.5h	-	
	2	-40°C	4h		Mechanical
	3	-40°C=>+85°C	2h		characteristics and
	4	+85°C	4h		specifications in
	5	+85°C=>+25°C	0.5h		electrical
	6	+25℃	1h		characteristics shall
Resistance to		soldering method			be satisfied. There shall be no
Soldering		55 ±5 °C, 220 ±5°C			shall be no excessive change in
heat	At elect	rode temperature of t	the specimen.		appearance.
		Temperature profi	le of reflow soldering		11
	300-	Solder	_		
	" 250 —	50000	mg		
	ang 250	40 s	· .		
	Soldering temperature		Slow cooling (S room temp		
	គ្ន គ្ន 150 —	Pre-heating Pre-heating	· .		
	Berin	 	· ************************************		
	중 100 —		1		
	50 —			N.	
	1 to 2 min. 10s 2 min. or more				
	The specimen shall be passed through the reflow				
	furnace with the condition shown in the above				
	profile for 1 time.				
	The specimen shall be stored at standard				
	atmosph	neric conditions for	1h, after which	ch the	

	measurement shall be made. Test board shall be 1.6 mm thick. Base material shall be glass fabric				
	base epoxy resin.				
Solder ability	Immerse the pins melt solder at 260°C+5/-0°C	More	then	95%	of
	for 5 sec.	total	area	of	the
		pins	shou	ıld	be
		cover	ed with	h sol	der

3.4Mechanical Test

Items	Conditions	Specifications
Vibration	600-3300rpm amplitude 1.5mm	
	3 directions 2 H each	
Drop	On maple plate from 1m high 3 times	
		There shall be no
Lead pull	Pull with 1kg force for 30 seconds	damage.
Lead bend	90° bending with 500g weigh 2 times	

3.5Voltage Discharge Test

ole voltage Dis	Seniar Se Test	
Item	Condition	Specifications
Surge	Between any two electrode	
	1000pF 4Mohm	There shall be no damage